## BAV99,215-JSM SILICON PLANAR HIGH SPEED SWITCHING DIODES

特点/Features:

速度快;



用途/Applications:

高速开关电路。



**SOT-23** 

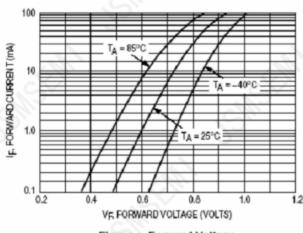
极限参数/Absolute maximum ratings(Ta=25℃)

参数/Parameter	符号/ Symbol	数值/Value	单位/Unit
反向电压/Reverse Voltage	$V_{R}$	70	V
正向电流/Forward Current	I <sub>F</sub>	200	mA
正向瞬间峰值电流/Peak Forward Surge Current	I <sub>FM(surge)</sub>	500	mA
功率/ Power Dissipation	P <sub>D</sub>	0.225	W
热阻/Thermal Resistance Junction to Ambient Air	R <sub>e JA</sub>	556	°C/W
结温/Junction Temperature	Tj	150	℃
储存温度/Storage Temperature	Tstg	-55 ~ 150	℃

电性能参数/Electrical characteristics (Ta=25℃)

参数/Parameter	符号	测试条件	最小值	最大值	单位
反向击穿电压/Reverse Breakdown Voltage	$V_{R}$	I <sub>R</sub> =100μ A	70		V
正向电压/Forward Voltage	V <sub>F1</sub>	I <sub>F</sub> =1mA	9///	0.715	V
	V <sub>F2</sub>	I <sub>F</sub> =10mA		0.855	٧
	V <sub>F3</sub>	I <sub>F</sub> =50mA		1	μА
	V <sub>F4</sub>	I <sub>F</sub> =150mA		1.25	μА
反向漏电流/Reverse Current	I <sub>R</sub>	V <sub>R</sub> =70V		2.5	μA
端电容/Capacitance Between Terminals	C <sub>T</sub>	V <sub>R</sub> =0,f=1MHz		1.5	pF
		$I_F = I_R = 10 \text{mA},$			
反向恢复时间/Reverse Recovery Time	t,	Irr=0.1x I <sub>R</sub> ,		6	nS
		R <sub>L</sub> =100Ω			

# 典型特性曲线图/Typical Characteristics



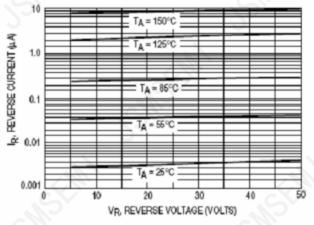


Figure 1. Forward Voltage

Figure 2 Leakage Current

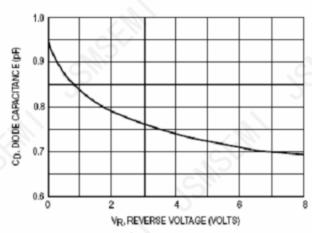


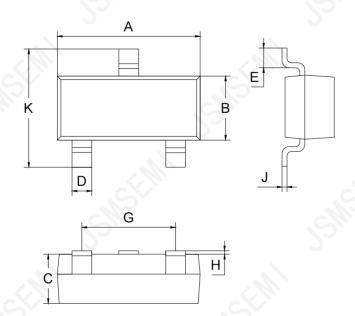
Figure 3 Capacitance



### 封装尺寸/PACKAGE OUTLINE

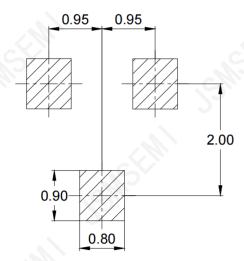
Plastic surface mounted package

SOT-23



SOT-23				
Dim	Min	Max		
Α	2.70	3.10		
В	1.10	1.50		
С	0.9	1.1		
D	0.3	0.5		
E	0.35	0.48		
G	1.80	2.00		
Н	0.02	0.1		
J	0.05	0.15		
K	2.20	2.60		
All Dimensions in mm				

### **SOLDERING FOOTPRINT**



Unit: mm

#### **Revision History**

Rev.	Change	Date
V1.0	Initial version	2/23/2024

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